

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 10/673,910
Applicant: Matsuda
Art Unit: 1762
Title: **METHOD FOR DEPOSITING METAL LAYERS USING
SEQUENTIAL FLOW DEPOSITION**
Docket No. RAJ-007
Confirmation No.: 7364

May 19, 2008

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT – AFTER FINAL REJECTION

This paper is responsive to the final Office Action dated February 14, 2008. The Examiner has indicated that claims 1-6, 8-20, 22, 24-26, 28-33, 35-41, 43-55, 57, 59-61, 63-70, and 72 -82 are pending and rejected. The present response includes the following:

Amendments to the Specification:	None
Amendments to the Claims:	None
Amendments to the Abstract:	None
Amendments to the Drawings:	None
Remarks:	Pages 2-3
Attachments:	None